

PS2561F-1, PS2561FL-1

R08DS0033EJ0200 Rev.2.00 Jul. 24, 2024

DIP PHOTOCOUPLER, OPERATING AMBIENT TEMPERATURE 110°C

DESCRIPTION

The PS2561F-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor.

The PS2561F-1 is in a plastic DIP (Dual In-line Package) and the PS2561FL-1 is lead bending type (Gull-wing) for surface mount.

FEATURES

- Operating ambient temperature: 110 °C
- High Isolation voltage (BV = 5 000 Vr.m.s.)
- High collector to emitter voltage (V_{CEO} = 80 V)
- High current transfer ratio (CTR = 450 % TYP.)
- High-speed switching ($t_r = 5 \mu s$ TYP., $t_f = 7 \mu s$ TYP.)
- Embossed tape product: PS2561FL-1-F3 : 2 000 pcs/reel
- · Pb-free product
- Safety standard
 - UL approved: UL1577, Double protection

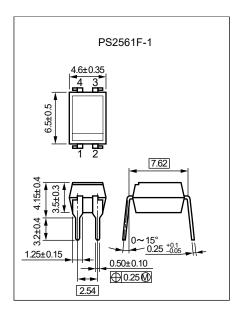
PIN CONNECTION (Top View) 4 3 1. Anode 2. Cathode 3. Emitter 4. Collector

APPLICATIONS

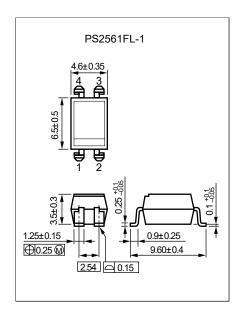
- Power meter
- Telephone/FAX.
- FA/OA equipment
- Programmable logic controller

PACKAGE DIMENSIONS (UNIT: mm)

DIP Type



Lead Bending Type

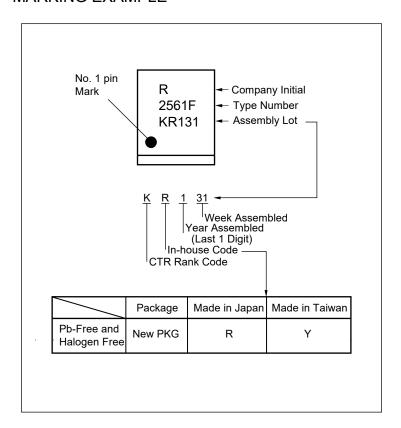


Weight: (4-pin DIP): 0.26 g (TYP.)

PHOTOCOUPLER CONSTRUCTION

Parameter	PS2561F-1, PS2561FL-1		
Air Distance (MIN.)	7 mm		
Creepage Distance (MIN.)	7 mm		
Isolation Distance (MIN.)	0.4 mm		

MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number *1	Solder Plating	Packing Style	Safety Standard	Application
		Specification		Approval	Part Number *2
PS2561F-1	PS2561F-1Y-A	Pb-Free and	Magazine case 100 pcs	UL Approved	PS2561F-1
PS2561FL-1	PS2561FL-1Y-A	Halogen Free			PS2561FL-1
PS2561FL-1-F3	PS2561FL-1Y-F3-A		Embossed Tape		
			2 000 pcs/reel		

Notes: *1. When specifying CTR rank, please add "/CTR rank" after Order Number.

ex. K rank: PS2561F-1Y-A/K

Notes: *2. For the application of the safety standard, the following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Reverse Voltage	V_R	6	V
	Forward Current (DC)	lF	30	mA
	Power Dissipation Derating	$\Delta P_D/^{\circ}C$	1.5	mW/°C
	Power Dissipation	PD	150	mW
	Peak Forward Current*1		1	Α
Transistor	Collector to Emitter Voltage	V_{CEO}	80	V
	Emitter to Collector Voltage	V_{ECO}	7	V
	Collector Current	Ic	50	mA
	Power Dissipation Derating	ΔP _C /°C	1.5	mW/°C
Power Dissipation		Pc	150	mW
Isolation Voltage*2		BV	5 000	Vr.m.s.
Operating Ambient Temperature		T _A	–55 to +110	°C
Storage Temperature		T_{stg}	-55 to +150	°C

Notes: *1. PW = 100 μ s, Duty Cycle = 1 %

^{*2.} AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-4 shorted together.

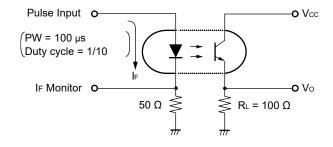
ELECTRICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}C$)

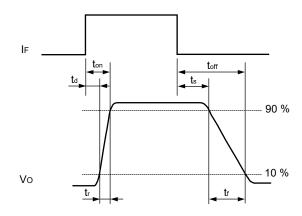
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA		1.2	1.4	V
	Reverse Current	I _R	V _R = 5 V			5	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		10		pF
Transistor	Collector to Emitter Dark Current	Iceo	I _F = 0 mA, V _{CE} = 80 V			100	nA
Coupled	Current Transfer Ratio	CTR	I _F = 5 mA, V _{CE} = 5 V	300	450	600	%
	(I _C /I _F)*1		I _F = 1 mA, V _{CE} = 5 V	60			
	Collector Saturation Voltage	V _{CE (sat)}	I _F = 10 mA, I _C = 2 mA			0.3	V
	Isolation Resistance	R _{I-O}	$V_{I-O} = 1.0 \text{ kV}_{DC}$	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.5		pF
	Rise Time*2	t _r	V _{CC} = 10 V, I _C = 2 mA,		5	18	μs
	Fall Time*2	t _f	R _L = 100 Ω		7	18	

Notes: *1. CTR rank

CTR Rank	CTR (%)	Conditions		
K	300 to 600	$I_F = 5 \text{ mA}, V_{CE} = 5 \text{ V}$		
K	60 and larger	I _F = 1 mA, V _{CE} = 5 V		

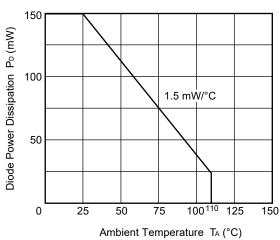
*2. Test circuit for switching time



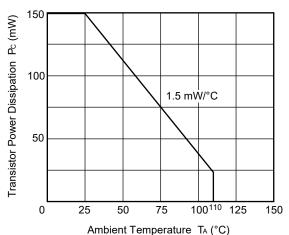


TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

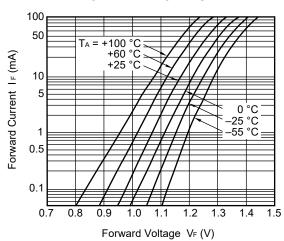




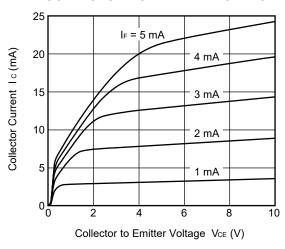
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



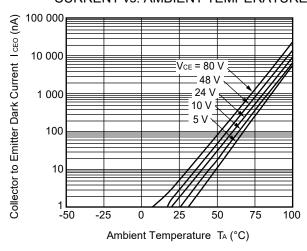
FORWARD CURRENT vs. FORWARD VOLTAGE



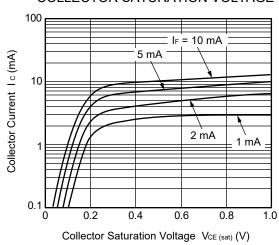
COLLECTOR CURRENT vs.
COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

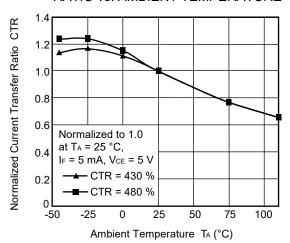


COLLECTOR CURRENT vs.
COLLECTOR SATURATION VOLTAGE

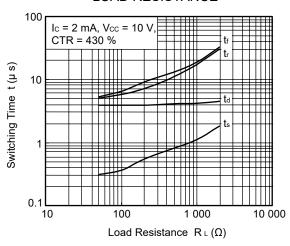


Remark The graphs indicate nominal characteristics.

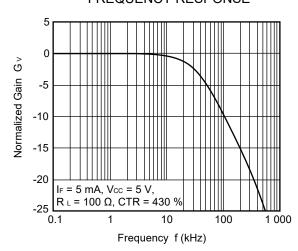
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

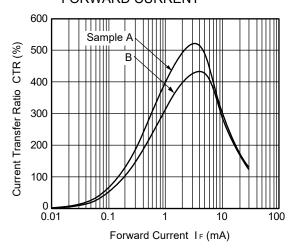


FREQUENCY RESPONSE

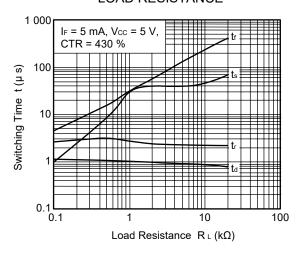


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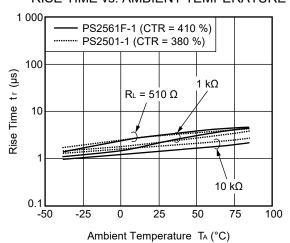
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



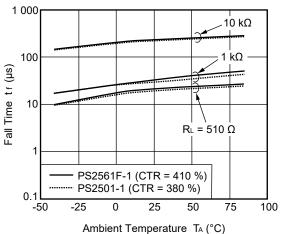
SWITCHING TIME vs. LOAD RESISTANCE



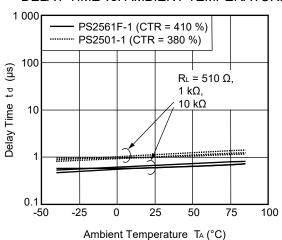
RISE TIME vs. AMBIENT TEMPERATURE *1



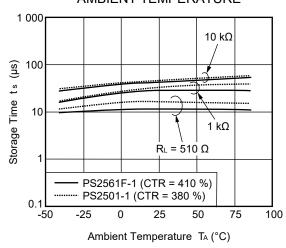
FALL TIME vs. AMBIENT TEMPERATURE *1



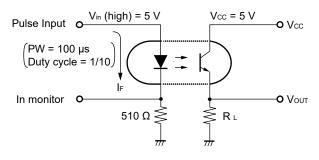
DELAY TIME vs. AMBIENT TEMPERATURE *1

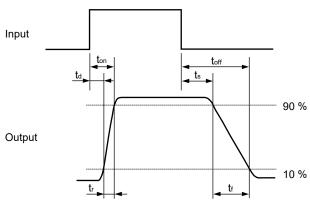


STORAGE TIME vs. AMBIENT TEMPERATURE *1



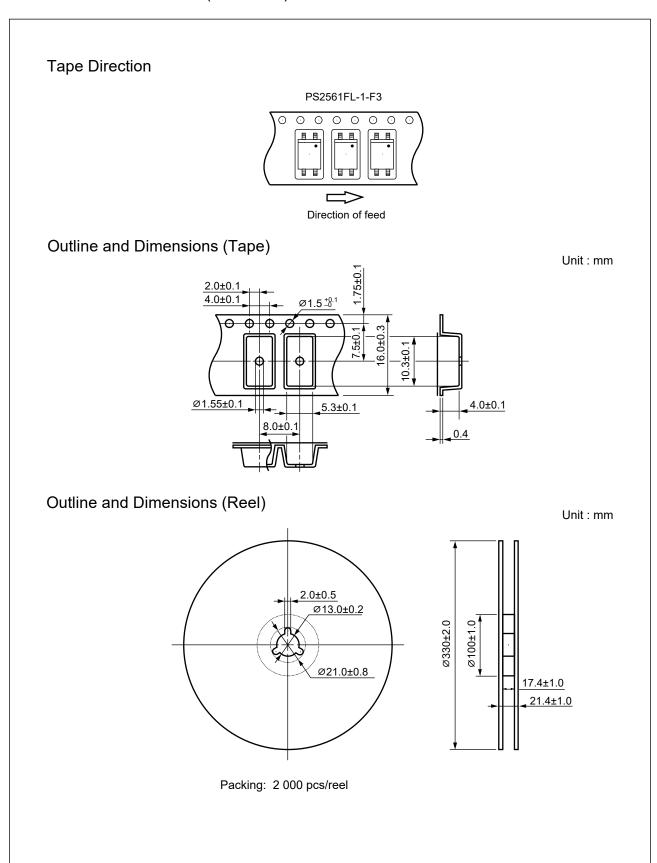
*1 Test circuit for switching time above



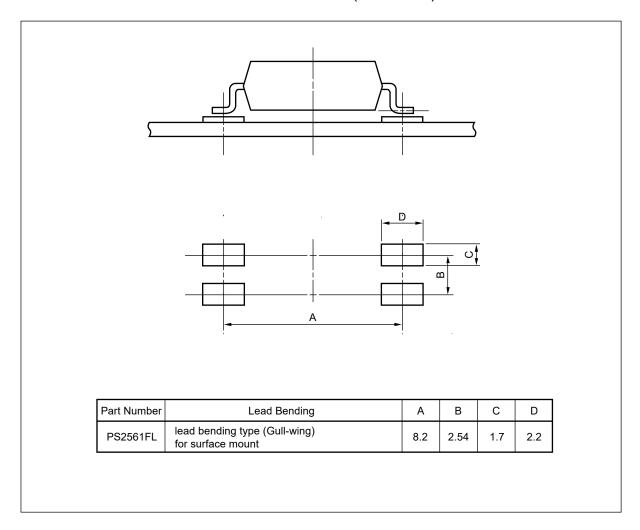


Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

Peak reflow temperature 260 °C or below (package surface temperature)

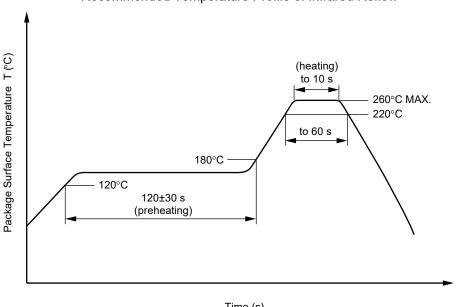
Time of peak reflow temperature 10 seconds or less

Time of temperature higher than 220 °C 60 seconds or less Time to preheat temperature from 120 to 180 °C 120 ±30 s

Number of reflows Three

Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

Temperature 260 °C or below (molten solder temperature)

Time 10 seconds or less

Preheating conditions 120 °C or below (package surface temperature)

Number of times One (Allowed to be dipped in solder including plastic mold portion.) Rosin flux containing small amount of chlorine (The flux with a maximum Flux

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak temperature (lead part temperature) 350 °C or below Time (per one side) 3 s or less

Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Place 1.5 to 2.0 mm or more away from the root of the lead

(4) Cautions

 Flux cleaning Avoid cleaning with Freon- or halogen-based (chlorinated etc.) solvents. Fixing/Coating Do not use fixing agents or coatings containing halogen-based substances

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2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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